ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® international and Pa	IPC. Bannockł	ourn, Illinois, A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarati the declaration e	on of the su	bstances all lower	within the manufacture relation of the manufacture relation of the materials for which we have a set of the manufacture of the	urer listed which the	item. Note: manufacture	if the item is an as er has engineering	sembly with low responsibility.	
				Form Type Distribute	*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information			
Supplier Information														
Company name* Company unique			ique ID	ue ID U			Unique ID Authority				Response Date*			
On Semiconductor											2021-02-04			
Contact Name Title - Contact			ct		Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards Product En			et Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repr			presentative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Prod			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	ester Item Number Mfr Item N		Number Mfr Item Name			Effective Date	e Version Manufacturing Site			Weight*	UOM	Unit Type		
	NTS810	NTS8100MFST3G LVFR 8A 100V S		SO8FL	8FL 2021						131.475	mg	Each	
Ianufacturing Proccess Informa	ntion							İ						
Terminal Plating / Grid Array M	laterial 7	ial Terminal Base Alloy J			L Rating	Peak Process Body Temperature Ma			e Max Time at Pea	k Tempera	ture Num	ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30	seco	nds 3			
omments														
vel 1 - maximum time at peak temperat	ure during so	ldering is 10-3	0 seconds											
or more information regarding material	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (Pl		dmium and quantity limit of 0.1% by mass (10 minated Diphenyl Ethers (PBDE), and Bis(2-et					
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in ifies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted				
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).						
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.									
Supplier Digital Signature	astislav Drska	Le							

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	1.713	mg	Supplier	Silicon (Si)	7440-21-3		1.713	mg	
Die Attach Solder	11.9	mg	Supplier	Silver (Ag)	7440-22-4		0.2975	mg	
			А	Lead (Pb)	7439-92-1	7a	11.0075	mg	
			Supplier	Tin (Sn)	7440-31-5		0.595	mg	
Lead Frame	69.776	mg	Supplier	Silver (Ag)	7440-22-4		0.0419	mg	
			Supplier	Iron (Fe)	7439-89-6		0.0698	mg	
			Supplier	Copper (Cu)	7440-50-8		69.6434	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.0209	mg	
Mold Compound-Black	47.136	mg		Phenolic Resin	proprietary data		2.3568	mg	
			Supplier	Epoxy Phenol Resin	Proprietary Data		3.2995	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.2357	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		41.244	mg	
Plating	0.95	mg	Supplier	Tin (Sn)	7440-31-5		0.95	mg	